

Display Elektronik GmbH

DATA SHEET

TFT MODULE

**DEM 240320J5 VMX-PW-N
(C-TOUCH)**

2,4" TFT + PCT

Product Specification

Ver.: 0

08.09.2025

Revision History

Revision	Date	Originator	Detail	Remarks
0	08.09.2025	LL	Initial Release	

Table of Contents

No.	Item	Page
1.	General Description	4
2.	Module Parameter	4
3.	Absolute Maximum Ratings	4
4.	DC Characteristics	5
5.	Backlight Characteristic	5
5.1.	Backlight Characteristics.....	5
5.2.	Backlighting circuit	5
6.	Touch Screen Panel Specifications.....	6
7.	Optical Characteristics	7
7.1.	Optical Characteristics	7
7.2.	Definition of Response Time	7
7.3.	Definition of Contrast Ratio	8
7.4.	Definition of Viewing Angles.....	8
7.5.	Definition of Color Appearance	9
7.6.	Definition of Surface Luminance, Uniformity and Transmittance.....	9
8.	Block Diagram and Power Supply	10
9.	Interface Pins Definition	11
10.	AC Characteristics	13
10.1.	8080 MCU 8-bit/16-bit Interface Timing Characteristics	13
10.2.	Serial interface characteristics	14
10.3.	Reset timing	16
11.	Quality Assurance	17
11.1.	Purpose	17
11.2.	Standard for Quality Test.....	17
11.3.	Nonconforming Analysis & Disposition	17
11.4.	Agreement Items.....	17
11.5.	Standard of the Product Visual Inspection	17
11.6.	Inspection Specification	18
11.7.	Classification of Defects.....	24
11.8.	Identification/marketing criteria	24
11.9.	Packaging	24
12.	Reliability Specification	25
13.	Precautions and Warranty	26
13.1.	Safety	26
13.2.	Handling	26
13.3.	Storage.....	26
13.4.	Metal Pin (Apply to Products with Metal Pins)	26
13.5.	Operation	27
13.6.	Static Electricity	27
13.7.	Limited Warranty	27
14.	Outline Drawing	28

1. General Description

The specification is a transmissive type color active matrix liquid crystal Display (LCD) which uses amorphous thin film transistor (TFT) as switching devices. This product is composed of a TFT-LCD Panel, Driver ICs, a Touch Panel and a Backlight Unit.

2. Module Parameter

Features	Details	Unit
Display Size (Diagonal)	2.4"	-
LCD Type	IPS TFT	-
Display Mode	Transmissive / Normal Black	-
Resolution	240 x RGB x320	Pixels
Module Outline	48.72 x 66.26 x 4.70 (Note1)	mm
Active Area	36.72 x 48.96	mm
Pixel Size	0.153 x 0.153	mm
Pixel Arrangement	RGB Vertical Stripe	-
Polarizer Surface Treatment	Anti-Glare	-
Display Colors	262k	-
Interface	16/8-Bit Bus Interface 3/4-Wire Serial Interface	-
With or without Touch Panel	With Capacitive Touch	-
Driver IC	ST7789T3 (Sitronix)	-
Operating Temperature	-30°C to +80°C	°C
Storage Temperature	-30°C to +80°C	°C
Weight	t.b.d.	g

Note 1: Exclusive hooks, posts, FFC/FPC tail etc.

3. Absolute Maximum Ratings

V_{SS}=0V, Ta=25°C

Item	Symbol	Min.	Max.	Unit
Supply Voltage	VCC	-0.3	4.6	V
	VCI	-0.3	4.6	V
Storage Temperature	T _{STG}	-30	+80	°C
Operating Temperature	T _{OP}	-30	+80	°C

Note 1: If Ta below +50°C, the maximal humidity is 90%RH, if Ta over 50°C, absolute humidity should be less than 60%RH.

Note 2: The response time will be extremely slow when the operating temperature is around -10°C, and the back ground will become darker at high temperature operating.

4. DC Characteristics

Item	Symbol	Min.	Typ.	Max.	Unit
Supply Voltage	VCC	2.4	2.8	3.3	V
	VCI	1.65	1.8	3.3	V
Logic Low Input Voltage	V _{IL}	GND	-	0.3*VCI	V
Logic High Input Voltage	V _{IH}	0.7*VCI	-	VCI	V
Logic Low Output Voltage	V _{OL}	GND	-	0.2*VCI	V
Logic High Output Voltage	V _{OH}	0.8*VCI	-	VCI	V
Current Consumption All Black	Logic Analog	I _{CC+} I _{IN}	t.b.d.	-	mA

5. Backlight Characteristic

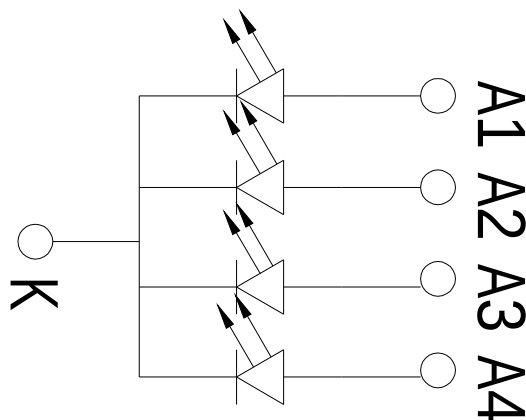
5.1. Backlight Characteristics

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward Voltage	V _F	T _a =25 °C, I _F =15mA/LED	2.8	3.1	3.4	V
Forward Current	I _F	T _a =25 °C, V _F =3.1V/LED	-	60	-	mA
Power Dissipation	P _D		-	186	-	mW
Uniformity	Avg		-	80	-	%
LED Lifetime (25°C)	-		-	50.000	-	Hrs
Drive Method	Constant Current					
LED Brand	Nichia					
LED Configuration	4 White LEDs in parallel					

Note1: LED lifetime defined as follows: The final brightness is at 50% of original brightness.

The environmental conducted under ambient air flow, at T_a=25°C ± 2°C, 60%RH ± 5%, I_F=15mA/LED

5.2. Backlighting Circuit



6. Touch Screen Panel Specifications

Item	CTP Description	
1	IC	FT5446
2	Interface	IIC
3	Operation voltage	2.8~3.3V
4	Interface signal voltage	2.8~3.3V
5	Surface hardness	≥6H
6	Operation temperature	-30 ° C~+80 ° C
7	Storage temperature	-30 ° C~+80 ° C
8	Strengthened Type	Chemical
9	Transmittance	≥85%
10	Origin of coordinates	T/L
11	Resolution Ratio	240*320

Item	Main layer define	Thickness/materials
1	Lens	0.7mm/Glass
2	Optical Glue	0.20mm
3	sensor	0.55mm

7. Optical Characteristics

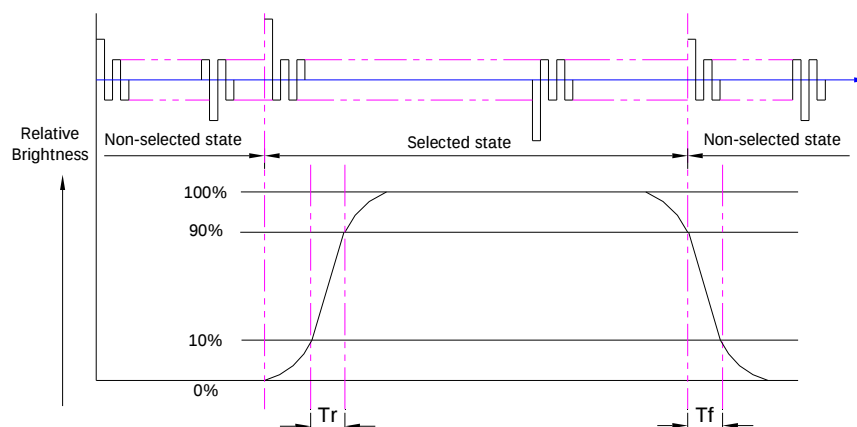
7.1. Optical Characteristics

Ta=25°C, VCC=2.8V

Backlight On (Transmissive Mode)	Item		Symbol	Condition	Specification			Unit
					Min.	Typ.	Max.	
	Luminance On TFT(I_f =15mA/LED)		Lv	Normally viewing angle $\theta_x = \varphi_y =0^{\circ}$	340	425	-	cd/m ²
	Contrast Ratio(See 7.3)		CR		(900)	(1200)	-	-
	Response time (See 7.2)		T _R +T _F		-	35	40	ms
	Chromaticity Transmissive (See 7.5)	Red	X _R		-	TBD	-	-
			Y _R		-	TBD	-	-
		Green	X _G		-	TBD	-	-
			Y _G		-	TBD	-	-
		Blue	X _B		-	TBD	-	-
			Y _B		-	TBD	-	-
		White	X _W		-	TBD	-	-
			Y _W		-	TBD	-	-
	Viewing Angle (See 7.4)	Horizontal	θ _{x+}	Center CR≥10	80	85	-	Deg.
			θ _{x-}		80	85	-	
		Vertical	φ _{y+}		80	85	-	
φ _{y-}			80		85	-		
NTSC Ratio(Gamut)				65	70	-	%	

7.2. Definition of Response Time

7.2.1. Normally Black Type (Negative)

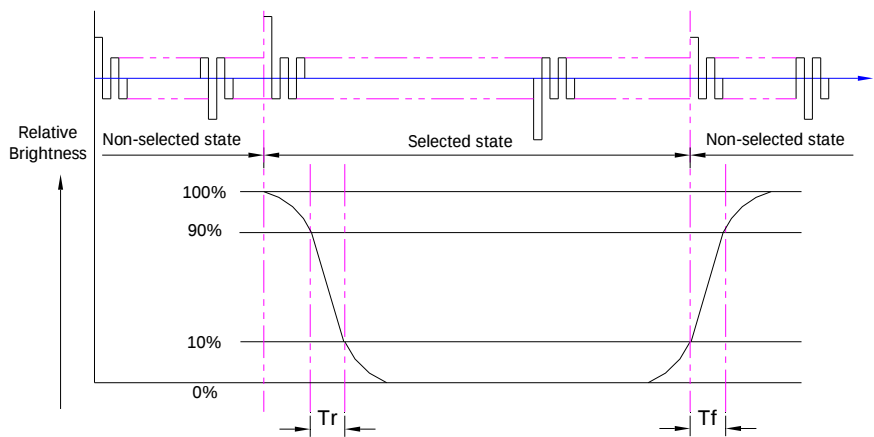


T_r is the time it takes to change from non-selected state with relative luminance 10% to selected state with relative luminance 90%;

T_f is the time it takes to change from selected state with relative luminance 90% to non-selected state with relative luminance 10%.

Note: Measuring machine: LCD-5100

7.2.2. Normally White Type (Positive)



Tr is the time it takes to change from non-selected stage with relative luminance 90% to selected state with relative luminance 10%;

Tf is the time it takes to change from selected state with relative luminance 10% to non-selected state with relative luminance 90%;

Note: Measuring machine: LCD-5100 or EQUI

7.3. Definition of Contrast Ratio

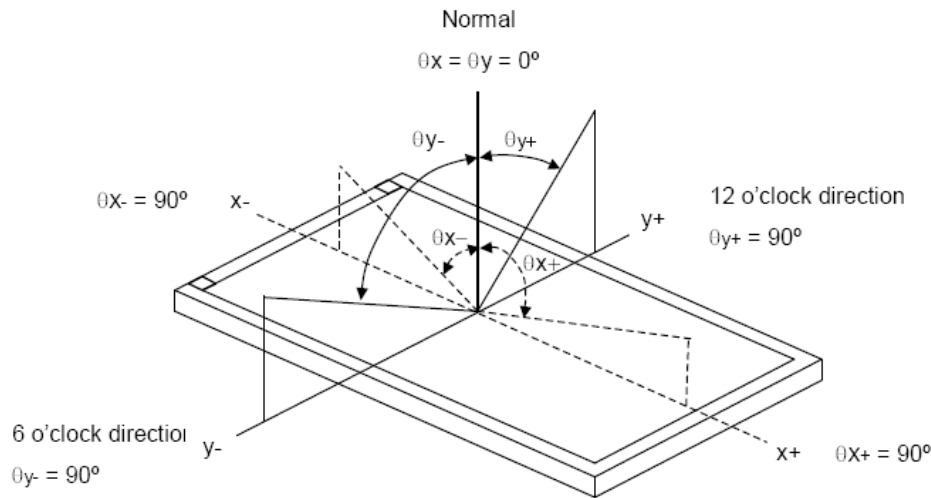
Contrast is measured perpendicular to display surface in reflective and transmissive mode.

The measurement condition is:

Measuring Equipment	Eldim or Equivalent
Measuring Point Diameter	3mm//1mm
Measuring Point Location	Active Area centre point
Test pattern	A: All Pixels white
	B: All Pixel black
Contrast setting	Maximum

Definitions: CR (Contrast) = Luminance of White Pixel / Luminance of Black Pixel

7.4. Definition of Viewing Angles



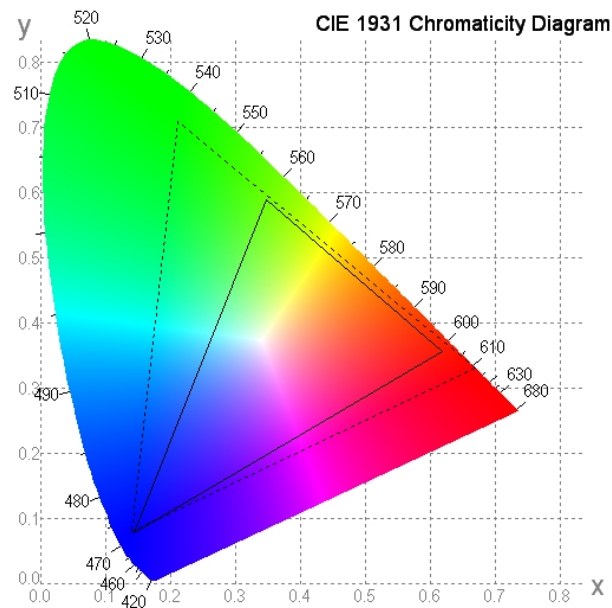
Measuring machine: LCD-5100 or EQUI

7.5. Definition of Color Appearance

R,G,B and W are defined by (x, y) on the IE chromaticity diagram

NTSC=area of RGB triangle/area of NTSC triangleX100%

Measuring picture: Red, Green, Blue and White (Measuring machine: BM-7)



7.6. Definition of Surface Luminance, Uniformity and Transmittance

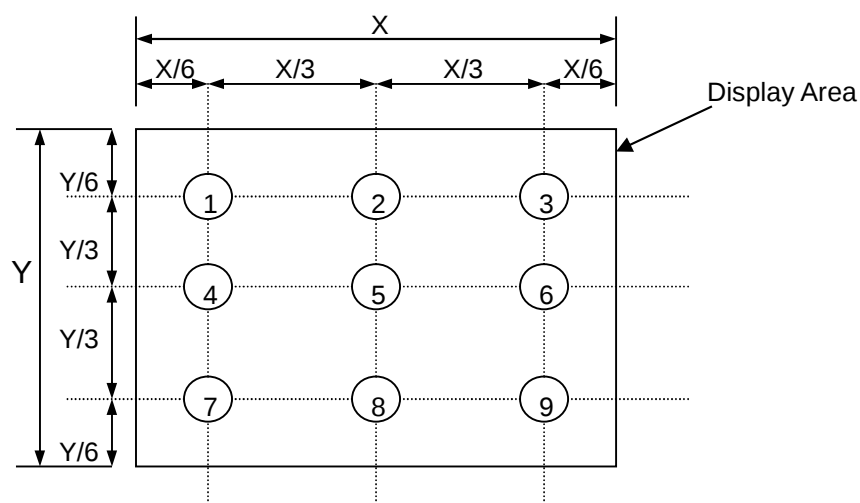
Using the transmissive mode measurement approach, measure the white screen luminance of the display panel and backlight.

7.6.1. Surface Luminance: $L_v = \text{average } (L_{P1}:L_{P9})$

7.6.2. Uniformity = Minimal ($L_{P1}:L_{P9}$) / Maximal ($L_{P1}:L_{P9}$) * 100%

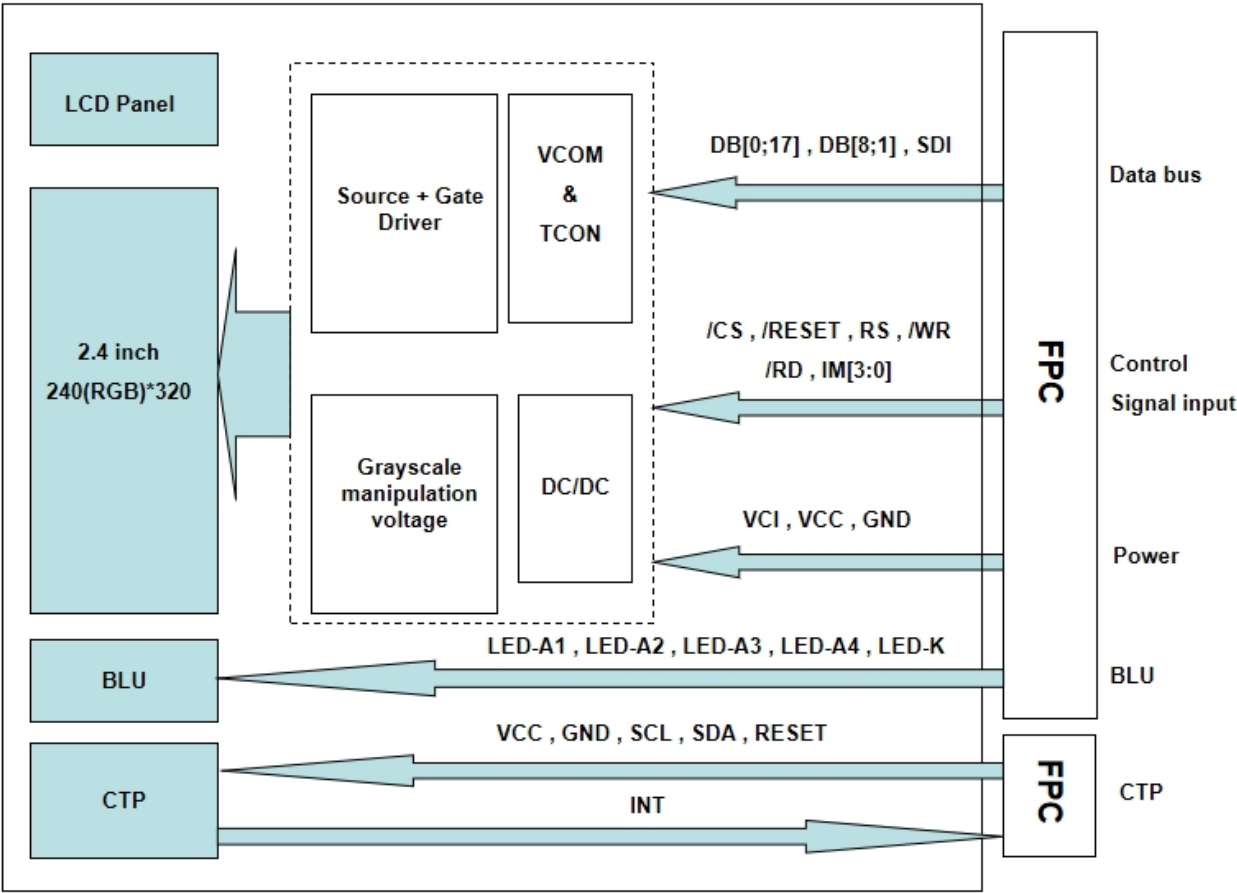
7.6.3. Transmittance = $L_v \text{ on LCD} / L_v \text{ on Backlight} * 100\%$

Note: Measuring machine: BM-7



Note: Test 3 brightness points below 3.5 inches(point2/5/8), and test 5 brightness points between 3.5-7 inches(point1/3/5/7/9). Test 9 brightness points above 7 inches(point1 to 9)

8. Block Diagram and Power Supply



9. Interface Pins Definition

No.	Symbol	Function	Remark
1	DB10	Data bus	
2	DB11	Data bus	
3	DB12	Data bus	
4	DB13	Data bus	
5	GND	Ground	
6	VCC	Power supply	
7	/CS	Chip select signal CSX=/CS	
8	RS	- Display data/command selection pin in parallel interface - This pin is used to be serial interface clock - D/CX=DCX=RS	DCX pin
9	/WR	- Write enable in MCU parallel interface - Display data/command selection pin in 4-line serial interface - WRX=/WR	
10	/RD	- Read enable in 8080 MCU parallel interface - If not used, please fix this pin at VDDI or DGND - RDX=/RD	
11	IM0	MCU interface mode select	NOTE1
12	IM3	MCU interface mode select	NOTE1
13	IM2	MCU interface mode select	NOTE1
14	SDI	SPI interface input pin	
15	SDO	SPI interface output pin.	
16	NC	No connection	
17	NC	No connection	
18	NC	No connection	
19	NC	No connection	
20	LED-K	Led cathode	
21	LED-A1	Led anode-1	
22	LED-A2	Led anode-2	
23	LED-A3	Led anode-3	
24	LED-A4	Led anode-4	
25	DB14	Data bus	
26	DB1	Data bus	
27	DB2	Data bus	
28	DB3	Data bus	
29	DB4	Data bus	
30	DB5	Data bus	
31	DB6	Data bus	
32	DB7	Data bus	
33	DB8	Data bus	

34	/RESET	Reset signal	
35	VCI	Power supply	
36	VCC	Power supply	
37	IM1	MCU interface mode select	NOTE1
38	DB15	Data bus	
39	DB16	Data bus	
40	DB17	Data bus	

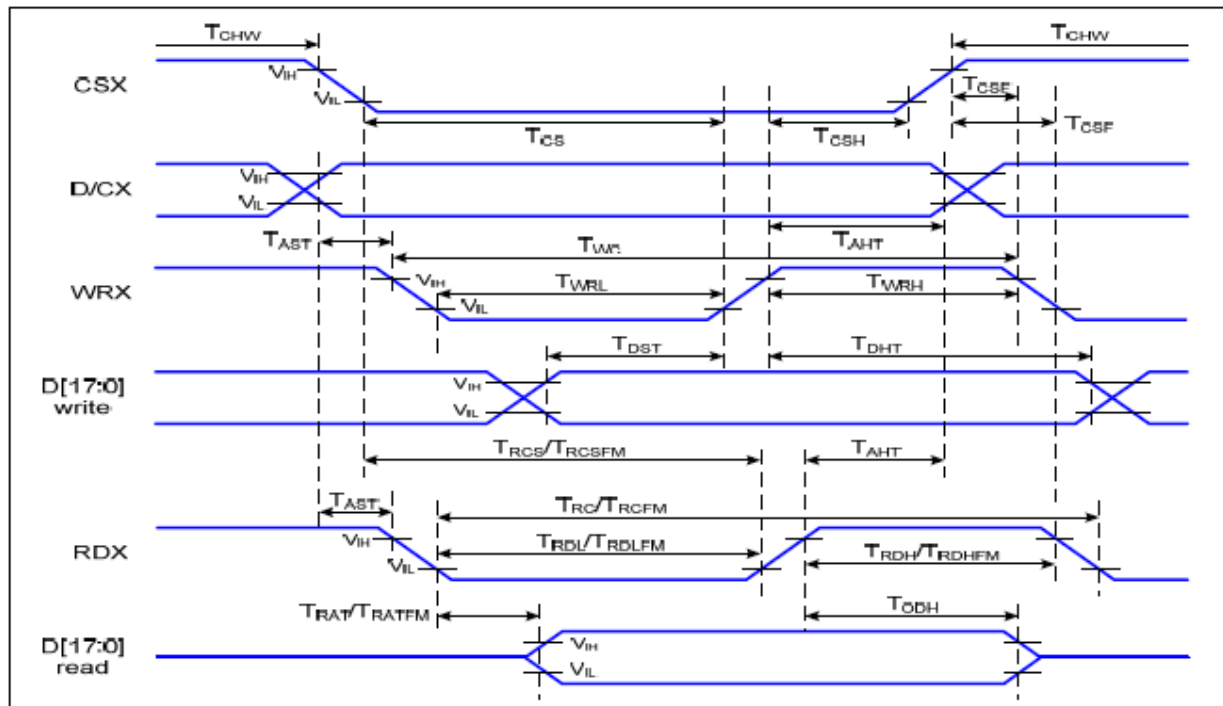
No.	Symbol	Function	Remark
1	GND	CTP Ground	
2	SCL	CTP Clock	
3	SDA	CTP Date	
4	INT	CTP Interrupt	
5	RESET	CTP Reset	
6	VCC	CTP Power supply	

NOTE1:

IM3	IM2	IM1	IM0	MCU-Interface Mode	DB Pin in use
1	0	0	0	80 MCU 16-bit bus interface II	D[17:10],D[8:1]
1	0	0	1	80 MCU 8-bit bus interface II	D[17:10]
1	1	0	1	3-wire 9-bit date serial interface II	SDI:In/SDO:OUT
1	1	1	0	4-wire 8-bit date serial interface II	SDI:In/SDO:OUT

10. AC Characteristics

10.1.8080 MCU 8-bit/16-bit Interface Timing Characteristics

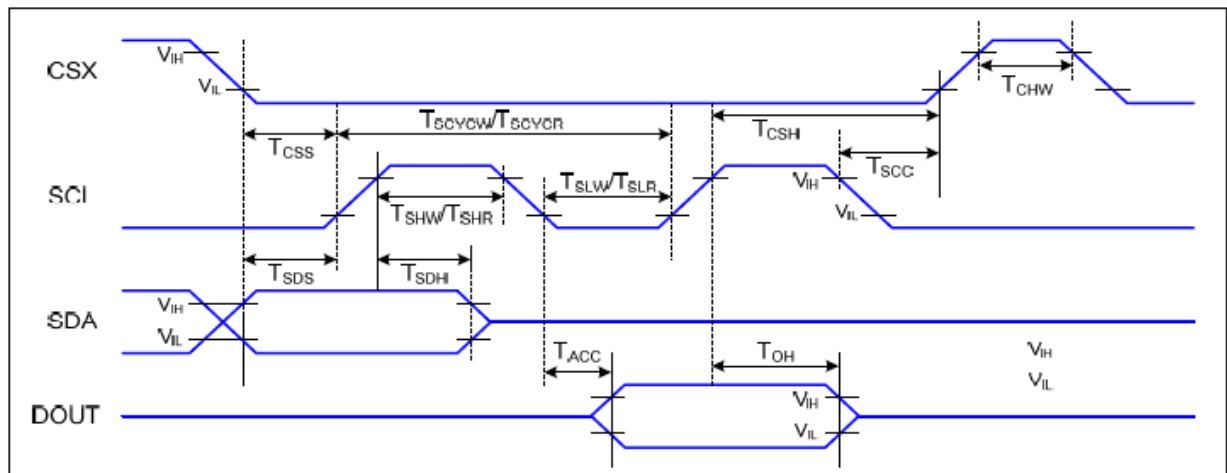


Signal	Symbol	Parameter	Min	Max	Unit	Description
D/CX	T_{AST}	Address setup time	0		ns	-
	T_{AHT}	Address hold time (Write/Read)	10		ns	
CSX	T_{CHW}	Chip select "H" pulse width	0		ns	-
	T_{CS}	Chip select setup time (Write)	15		ns	
	T_{RCS}	Chip select setup time (Read ID)	45		ns	
	T_{RCSFM}	Chip select setup time (Read FM)	355		ns	
	T_{CSF}	Chip select wait time (Write/Read)	10		ns	
	T_{CSH}	Chip select hold time	10		ns	
WRX	T_{WC}	Write cycle	66		ns	
	T_{WRH}	Control pulse "H" duration	15		ns	
	T_{WRL}	Control pulse "L" duration	15		ns	
RDX (ID)	T_{RC}	Read cycle (ID)	160		ns	When read ID data
	T_{RDH}	Control pulse "H" duration (ID)	90		ns	
	T_{RDL}	Control pulse "L" duration (ID)	45		ns	
RDX (FM)	T_{RCFM}	Read cycle (FM)	450		ns	When read from frame memory
	T_{RDHFM}	Control pulse "H" duration (FM)	90		ns	
	T_{RDLFM}	Control pulse "L" duration (FM)	355		ns	
D[17:0]	T_{DST}	Data setup time	10		ns	For CL=30pF

	T_{DHT}	Data hold time	10		ns	
	T_{RAT}	Read access time (ID)		40	ns	
	T_{RATFM}	Read access time (FM)		340	ns	
	T_{ODH}	Output disable time	20	80	ns	

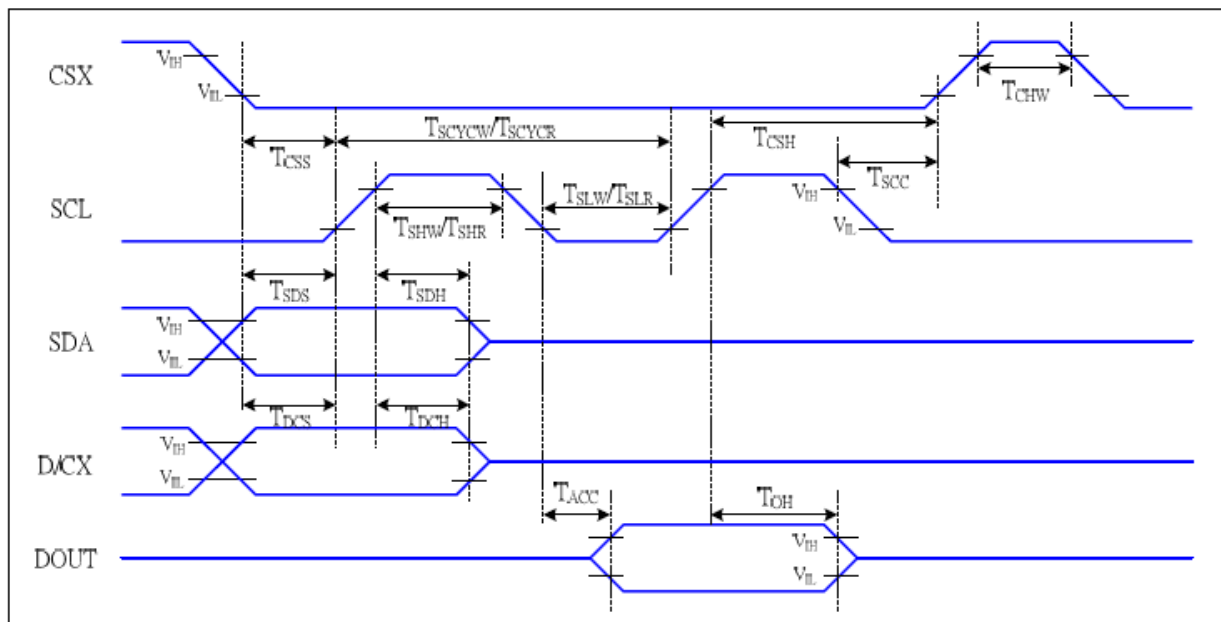
10.2. Serial interface characteristics

10.2.1 3-Line Serial



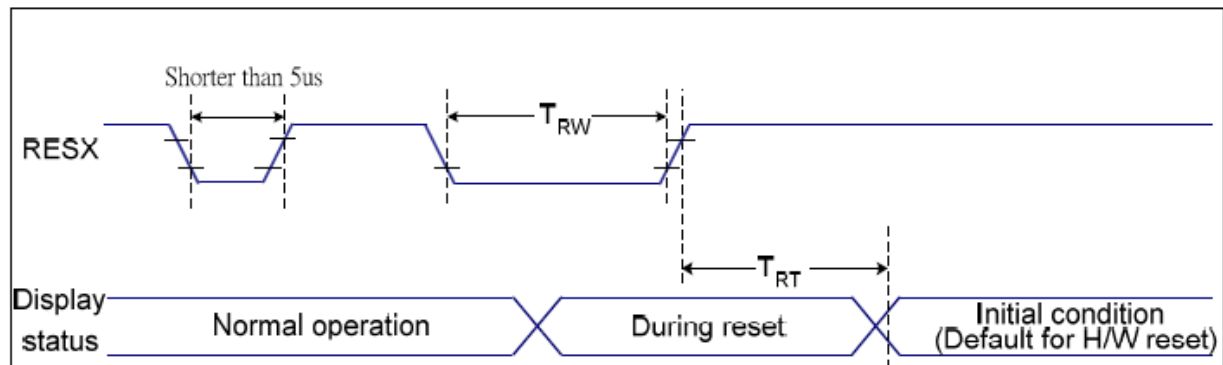
Signal	Symbol	Parameter	Min	Max	Unit	Description
CSX	T_{CSS}	Chip select setup time (write)	15		ns	
	T_{CSH}	Chip select hold time (write)	15		ns	
	T_{CSS}	Chip select setup time (read)	60		ns	
	T_{SCC}	Chip select hold time (read)	65		ns	
	T_{CHW}	Chip select "H" pulse width	40		ns	
SCL	T_{SCYCW}	Serial clock cycle (Write)	16		ns	
	T_{SHW}	SCL "H" pulse width (Write)	7		ns	
	T_{SLW}	SCL "L" pulse width (Write)	7		ns	
	T_{SCYCR}	Serial clock cycle (Read)	150		ns	
	T_{SHR}	SCL "H" pulse width (Read)	60		ns	
	T_{SLR}	SCL "L" pulse width (Read)	60		ns	
SDA (DIN)	T_{SDS}	Data setup time	7		ns	
	T_{SDH}	Data hold time	7		ns	
DOUT	T_{ACC}	Access time	10	50	ns	For maximum CL=30pF
	T_{OH}	Output disable time	15	50	ns	For minimum CL=8pF

10.2.2 4-Line Serial



Signal	Symbol	Parameter	MIN	MAX	Unit	Description
CSX	T_{CSS}	Chip select setup time (write)	15		ns	
	T_{CSH}	Chip select hold time (write)	15		ns	
	T_{CSS}	Chip select setup time (read)	60		ns	
	T_{SCC}	Chip select hold time (read)	65		ns	
	T_{CHW}	Chip select "H" pulse width	40		ns	
SCL	T_{SCYCW}	Serial clock cycle (Write)	16		ns	-write command & data ram
	T_{SHW}	SCL "H" pulse width (Write)	7		ns	
	T_{SLW}	SCL "L" pulse width (Write)	7		ns	
	T_{SCYCR}	Serial clock cycle (Read)	150		ns	-read command & data ram
	T_{SHR}	SCL "H" pulse width (Read)	60		ns	
	T_{SLR}	SCL "L" pulse width (Read)	60		ns	
D/CX	T_{DCS}	D/CX setup time	10		ns	
	T_{DCH}	D/CX hold time	10		ns	
SDA (DIN)	T_{SDS}	Data setup time	7		ns	
	T_{SDH}	Data hold time	7		ns	
DOUT	T_{ACC}	Access time	10	50	ns	For maximum CL=30pF
	T_{OH}	Output disable time	15	50	ns	For minimum CL=8pF

10.3. Reset Timing



Related Pins	Symbol	Parameter	MIN	MAX	Unit
RESX	TRW	Reset pulse duration	10	-	us
	TRT	Reset cancel	-	5 (Note 1, 5)	ms
				120 (Note 1, 6, 7)	ms

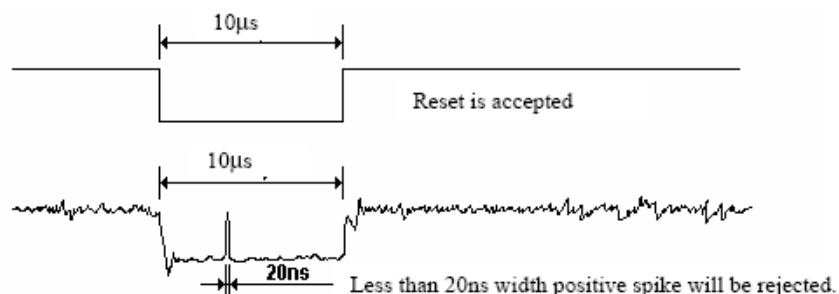
Notes:

1. The reset cancel includes also required time for loading ID bytes, VCOM setting and other settings from NVM (or similar device) to registers. This loading is done every time when there is HW reset cancel time (t_{RT}) within 5 ms after a rising edge of RESX.
2. Spike due to an electrostatic discharge on RESX line does not cause irregular system reset according to the table below:

RESX Pulse	Action
Shorter than 5us	Reset Rejected
Longer than 9us	Reset
Between 5us and 9us	Reset starts

3. During the Resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in Sleep Out –mode. The display remains the blank state in Sleep In –mode.) and then return to Default condition for Hardware Reset.

4. Spike Rejection also applies during a valid reset pulse as shown below:



5. When Reset applied during Sleep In Mode.
6. When Reset applied during Sleep Out Mode.
7. It is necessary to wait 5msec after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120msec.

11. Quality Assurance

11.1.Purpose

This standard for Quality Assurance assures the quality of LCD module products supplied to customer.

11.2.Standard for Quality Test

12.2.1 Sampling Plan:

GB2828.1-2012

Single sampling, general inspection level II

12.2.2 Sampling Criteria:

Visual inspection: AQL 1.5

Electrical functional: AQL 0.65.

12.2.3 Reliability Test:

Detailed requirement refer to Reliability Test Specification.

11.3.Nonconforming Analysis & Disposition

12.3.1 Nonconforming analysis:

12.3.1.1 Customer should provide overall information of non-conforming sample for their complaints.

12.3.1.2 After receipt of detailed information from customer, the analysis of nonconforming parts usually should be finished in one week.

12.3.1.3 If cannot finish the analysis on time, customer will be notified with the progress status.

12.3.2 Disposition of nonconforming:

12.3.2.1 Non-conforming product over PPM level will be replaced.

12.3.2.2 The cause of non-conformance will be analyzed. Corrective action will be discussed and implemented.

11.4.Agreement Items

Shall negotiate with customer if the following situation occurs:

12.4.1 There is any discrepancy in standard of quality assurance.

12.4.2 Additional requirement to be added in product specification.

12.4.3 Any other special problem.

11.5.Standard of the Product Visual Inspection

12.5.1 Appearance inspection:

12.5.1.1 The inspection must be under illumination about 1000 – 1500 lx, and the distance of view must be at 30cm ± 2cm.

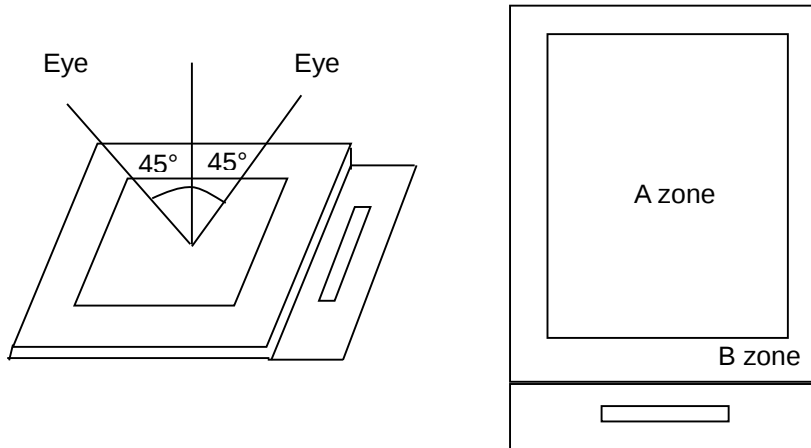
12.5.1.2 The viewing angle should be 45° from the vertical line without reflection light or follows customer's viewing angle specifications.

12.5.1.3 Definition of area: A Zone: Active Area, B Zone: Viewing Area,

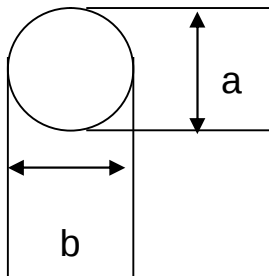
12.5.2 Basic principle:

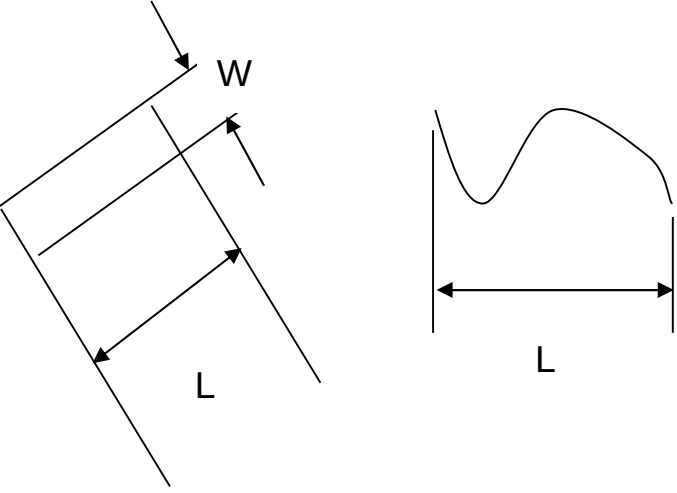
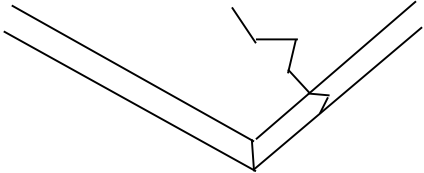
12.5.2.1 A set of sample to indicate the limit of acceptable quality level must be discussed by both us and customer when there is any dispute happened.

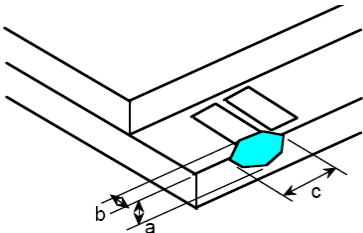
12.5.2.2 New item must be added on time when it is necessary.



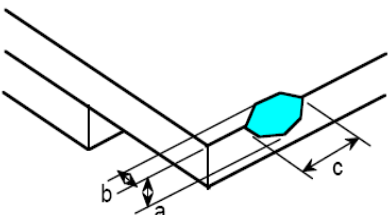
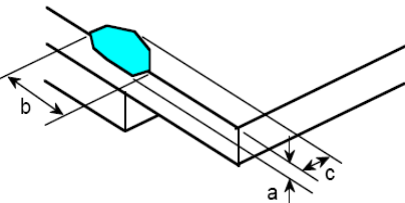
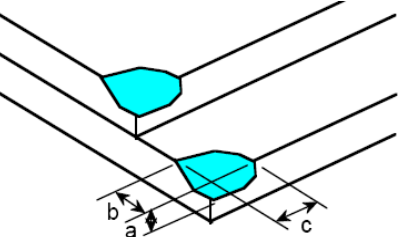
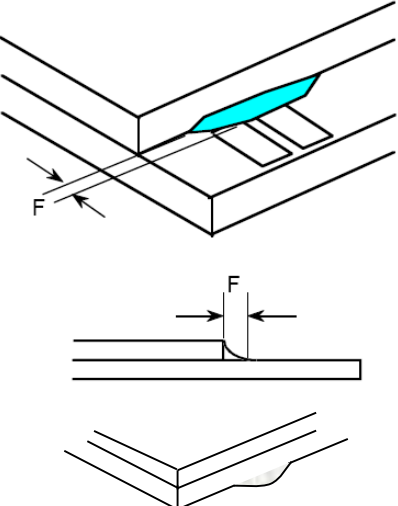
11.6. Inspection Specification

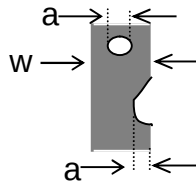
No.	Item	Criteria (Unit: mm)																			
01	Black / White spot Foreign material (Round type) Pinholes Stain Particles inside cell. (Minor defect)	 $\varphi = (a + b) / 2$	<table><tr><th>Size \ Area</th><th>Acc. Qty</th></tr><tr><td>$\varphi \leq 0.10$</td><td>Ignore</td></tr><tr><td>$0.10 < \varphi \leq 0.15$</td><td>2</td></tr><tr><td>$0.15 < \varphi \leq 0.25$</td><td>1</td></tr><tr><td>$0.25 < \varphi$</td><td>0</td></tr><tr><td>Total</td><td>2 no include $\varphi \leq 0.10$</td></tr></table>		Size \ Area	Acc. Qty	$\varphi \leq 0.10$	Ignore	$0.10 < \varphi \leq 0.15$	2	$0.15 < \varphi \leq 0.25$	1	$0.25 < \varphi$	0	Total	2 no include $\varphi \leq 0.10$					
			Size \ Area	Acc. Qty																	
$\varphi \leq 0.10$	Ignore																				
$0.10 < \varphi \leq 0.15$	2																				
$0.15 < \varphi \leq 0.25$	1																				
$0.25 < \varphi$	0																				
Total	2 no include $\varphi \leq 0.10$																				
Distance between 2 defects should more than 3mm apart.																					
02	Electrical Defect (Minor defect)	<table><tr><th></th><th>Display Area</th><th>Total</th><th rowspan="4">Note1</th></tr><tr><td>Bright dot</td><td>0</td><td>0</td></tr><tr><td>Dark dot</td><td>$N \leq 2$</td><td>$N \leq 2$</td></tr><tr><td>Total dot</td><td>$N \leq 2$</td><td>$N \leq 2$</td></tr><tr><td>Mura</td><td colspan="2">Not visible through 5% ND filters.</td><td>Note 2</td></tr></table>				Display Area	Total	Note1	Bright dot	0	0	Dark dot	$N \leq 2$	$N \leq 2$	Total dot	$N \leq 2$	$N \leq 2$	Mura	Not visible through 5% ND filters.		Note 2
			Display Area	Total	Note1																
Bright dot	0	0																			
Dark dot	$N \leq 2$	$N \leq 2$																			
Total dot	$N \leq 2$	$N \leq 2$																			
Mura	Not visible through 5% ND filters.		Note 2																		
Remark:																					
1. Bright dot caused by scratch and foreign object accords to item 1.																					

03	Black and White line Scratch Foreign material (Line type) (Minor defect)	 <table border="1" data-bbox="568 723 1193 1030"> <thead> <tr> <th>Length</th><th>Width</th><th>Acc. Qty</th></tr> </thead> <tbody> <tr> <td>/</td><td>$W \leq 0.03$</td><td>Ignore</td></tr> <tr> <td>$L \leq .5$</td><td>$0.03 < W \leq 0.5$</td><td>3</td></tr> <tr> <td>$L \leq 2.5$</td><td>$0.05 < W \leq 0.10$</td><td>2</td></tr> <tr> <td>/</td><td>$0.1 < W$</td><td>0</td></tr> <tr> <td colspan="2">Total</td><td>3</td></tr> </tbody> </table> Distance between 2 defects should more than 3mm apart. Scratches not viewable through the back of the display are acceptable.	Length	Width	Acc. Qty	/	$W \leq 0.03$	Ignore	$L \leq .5$	$0.03 < W \leq 0.5$	3	$L \leq 2.5$	$0.05 < W \leq 0.10$	2	/	$0.1 < W$	0	Total		3
Length	Width	Acc. Qty																		
/	$W \leq 0.03$	Ignore																		
$L \leq .5$	$0.03 < W \leq 0.5$	3																		
$L \leq 2.5$	$0.05 < W \leq 0.10$	2																		
/	$0.1 < W$	0																		
Total		3																		
04	Glass Crack (Minor defect)	 Crack is potential to enlarge, any type is not allowed.																		

05	Glass Chipping Pad Area: (Minor defect) 	

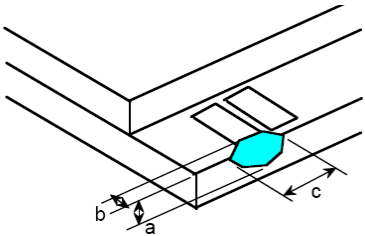
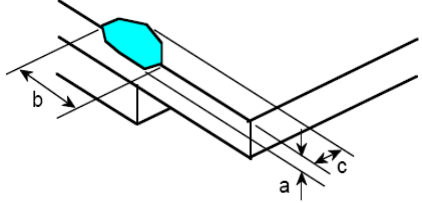
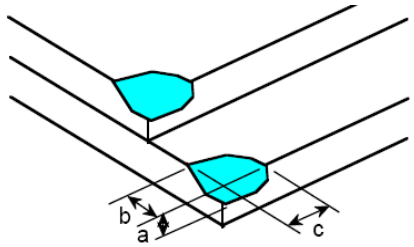
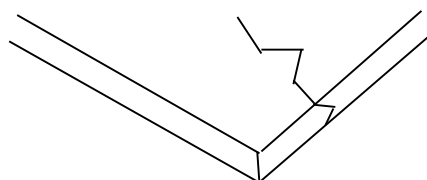
Length and Width	Acc. Qty
$c > 3.0, b < 1.0$	1
$c < 3.0, b < 1.0$	3
$a < \text{Glass Thickness}$	

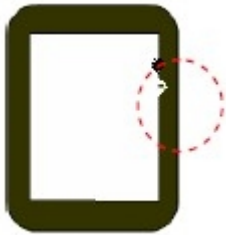
06	Glass Chipping Rear of Pad Area: (Minor defect) 	<table><tr><th>Length and Width</th><th>Acc. Qty</th></tr><tr><td>$c > 3.0, b < 1.0$</td><td>1</td></tr><tr><td>$c < 3.0, b < 1.0$</td><td>2</td></tr><tr><td>$c < 3.0, b < 0.5$</td><td>4</td></tr><tr><td colspan="2">$a < \text{Glass Thickness}$</td></tr></table>	Length and Width	Acc. Qty	$c > 3.0, b < 1.0$	1	$c < 3.0, b < 1.0$	2	$c < 3.0, b < 0.5$	4	$a < \text{Glass Thickness}$	
Length and Width	Acc. Qty											
$c > 3.0, b < 1.0$	1											
$c < 3.0, b < 1.0$	2											
$c < 3.0, b < 0.5$	4											
$a < \text{Glass Thickness}$												
07	Glass Chipping Except Pad Area: (Minor defect) 	<table><tr><th>Length and Width</th><th>Acc. Qty</th></tr><tr><td>$c > 3.0, b < 1.0$</td><td>1</td></tr><tr><td>$c < 3.0, b < 1.0$</td><td>2</td></tr><tr><td>$c < 3.0, b < 0.5$</td><td>4</td></tr><tr><td colspan="2">$a < \text{Glass Thickness}$</td></tr></table>	Length and Width	Acc. Qty	$c > 3.0, b < 1.0$	1	$c < 3.0, b < 1.0$	2	$c < 3.0, b < 0.5$	4	$a < \text{Glass Thickness}$	
Length and Width	Acc. Qty											
$c > 3.0, b < 1.0$	1											
$c < 3.0, b < 1.0$	2											
$c < 3.0, b < 0.5$	4											
$a < \text{Glass Thickness}$												
08	Glass Corner Chipping: (Minor defect) 	<table><tr><th>Length and Width</th><th>Acc. Qty</th></tr><tr><td>$c < 3.0, b < 3.0$</td><td>Ignore</td></tr><tr><td colspan="2">$a < \text{Glass Thickness}$</td></tr></table>	Length and Width	Acc. Qty	$c < 3.0, b < 3.0$	Ignore	$a < \text{Glass Thickness}$					
Length and Width	Acc. Qty											
$c < 3.0, b < 3.0$	Ignore											
$a < \text{Glass Thickness}$												
09	Glass Burr: (Minor defect) 	<table><tr><th>Length</th><th>Acc. Qty</th></tr><tr><td>$F < 1.0$</td><td>Ignore</td></tr></table> Glass burr don't affect assemble and module dimension.	Length	Acc. Qty	$F < 1.0$	Ignore						
Length	Acc. Qty											
$F < 1.0$	Ignore											

10	FPC Defect: (Minor defect) 	10.1 Dent, pinhole width $a < w/3$. (w: circuitry width.) 10.2 Open circuit is unacceptable. 10.3 No oxidation, contamination and distortion.										
11	Bubble on Polarizer (Minor defect)	<table><tr><th>Diameter</th><th>Acc. Qty</th></tr><tr><td>$\varphi \leq 0.20$</td><td>Ignore</td></tr><tr><td>$0.20 < \varphi \leq 0.30$</td><td>4</td></tr><tr><td>$0.30 < \varphi \leq 0.50$</td><td>1</td></tr><tr><td>$0.50 < \varphi$</td><td>None</td></tr></table>	Diameter	Acc. Qty	$\varphi \leq 0.20$	Ignore	$0.20 < \varphi \leq 0.30$	4	$0.30 < \varphi \leq 0.50$	1	$0.50 < \varphi$	None
Diameter	Acc. Qty											
$\varphi \leq 0.20$	Ignore											
$0.20 < \varphi \leq 0.30$	4											
$0.30 < \varphi \leq 0.50$	1											
$0.50 < \varphi$	None											
12	Dent on Polarizer (Minor defect)	<table><tr><th>Diameter</th><th>Acc. Qty</th></tr><tr><td>$\varphi \leq 0.20$</td><td>Ignore</td></tr><tr><td>$0.20 < \varphi \leq 0.30$</td><td>4</td></tr><tr><td>$0.30 < \varphi \leq 0.50$</td><td>1</td></tr><tr><td>$0.50 < \varphi$</td><td>None</td></tr></table>	Diameter	Acc. Qty	$\varphi \leq 0.20$	Ignore	$0.20 < \varphi \leq 0.30$	4	$0.30 < \varphi \leq 0.50$	1	$0.50 < \varphi$	None
Diameter	Acc. Qty											
$\varphi \leq 0.20$	Ignore											
$0.20 < \varphi \leq 0.30$	4											
$0.30 < \varphi \leq 0.50$	1											
$0.50 < \varphi$	None											
13	Bezel	13.1 No rust, distortion on the Bezel. 13.2 No visible fingerprints, stains or other contamination.										
14	PCB	14.1 No distortion or contamination on PCB terminals. 14.2 All components on PCB must same as documented on the BOM/component layout. 14.3 Follow IPC-A-600F.										
15	Soldering	Follow IPC-A-610C standard										
16	Electrical Defect (Major defect)	The below defects must be rejected. 16.1 Missing vertical / horizontal segment, 16.2 Abnormal Display. 16.3 No function or no display. 16.4 Current exceeds product specifications. 16.5 LCD viewing angle defect. 16.6 No Backlight. 16.7 Dark Backlight. 16.8 Touch Panel no function.										

Remark: LCD Panel Broken shall be rejected. Defect out of LCD viewing area is acceptable.

Inspection Specification for the Capacitive Touch Panel

01	Chipping Pad Area(Not include the cover lens): (Minor defect) 	The chip is seriously influence the product's function, any type is not allowed.						
02	Chipping Except Pad Area(Not include the cover lens): (Minor defect) 	<table><tr><th>Length and Width</th><th>Acc. Qty</th></tr><tr><td>$c < 1.5, b < 1$</td><td>$N \leq 5$</td></tr><tr><td colspan="2">$a < 1/2$ Glass Thickness</td></tr></table>	Length and Width	Acc. Qty	$c < 1.5, b < 1$	$N \leq 5$	$a < 1/2$ Glass Thickness	
Length and Width	Acc. Qty							
$c < 1.5, b < 1$	$N \leq 5$							
$a < 1/2$ Glass Thickness								
03	Corner Chipping(Not include the cover lens): (Minor defect) 	<table><tr><th>Length and Width</th><th>Acc. Qty</th></tr><tr><td>$c < 1.5, b < 0.5$</td><td>Ignore</td></tr><tr><td colspan="2">$a < 1/2$ Glass Thickness</td></tr></table>	Length and Width	Acc. Qty	$c < 1.5, b < 0.5$	Ignore	$a < 1/2$ Glass Thickness	
Length and Width	Acc. Qty							
$c < 1.5, b < 0.5$	Ignore							
$a < 1/2$ Glass Thickness								
04	Crack: (Minor defect)	 Crack is potential to enlarge, any type is not allowed.						
05	Cover lens must be without any chips, cracks or other damage when viewed from the front.							

06	Same/Different color spot 	D: Diameter W: width L: length <table><tr><th>Diameter</th><th>Acc. Qty</th></tr><tr><td>D < 0.20</td><td>Ignore</td></tr></table> Active Area: <table><tr><th>Diameter</th><th>Acc. Qty</th></tr><tr><td>0.20 < D ≤ 0.30</td><td>2</td></tr><tr><td>0.30 < D ≤ 0.50</td><td>1</td></tr><tr><td>D>0.5</td><td>NG</td></tr></table> Viewing Area : <table><tr><th>Diameter</th><th>Acc. Qty</th></tr><tr><td>D<0.20</td><td>Ignore</td></tr><tr><td>0.20 < D ≤ 0.5</td><td>3</td></tr><tr><td>D>0.5</td><td>NG</td></tr></table> Distance between 2 defects should more than15mm apart.	Diameter	Acc. Qty	D < 0.20	Ignore	Diameter	Acc. Qty	0.20 < D ≤ 0.30	2	0.30 < D ≤ 0.50	1	D>0.5	NG	Diameter	Acc. Qty	D<0.20	Ignore	0.20 < D ≤ 0.5	3	D>0.5	NG
Diameter	Acc. Qty																					
D < 0.20	Ignore																					
Diameter	Acc. Qty																					
0.20 < D ≤ 0.30	2																					
0.30 < D ≤ 0.50	1																					
D>0.5	NG																					
Diameter	Acc. Qty																					
D<0.20	Ignore																					
0.20 < D ≤ 0.5	3																					
D>0.5	NG																					
07	Cover lens line Scratch 	<table><tr><th>Length</th><th>Width</th><th>Acc. Qty</th></tr><tr><td>/</td><td>W ≤ 0.08mm</td><td>Ignore</td></tr><tr><td>L ≤ 5</td><td>0.08 < W ≤ 0.15</td><td>2</td></tr><tr><td>L ≤ 3</td><td>0.15 < W ≤ 0.20</td><td>1</td></tr><tr><td>-</td><td>W>0.2</td><td>NG</td></tr><tr><td>L>5</td><td>-</td><td>NG</td></tr></table> Distance between 2 defects should more than15mm apart.	Length	Width	Acc. Qty	/	W ≤ 0.08mm	Ignore	L ≤ 5	0.08 < W ≤ 0.15	2	L ≤ 3	0.15 < W ≤ 0.20	1	-	W>0.2	NG	L>5	-	NG		
Length	Width	Acc. Qty																				
/	W ≤ 0.08mm	Ignore																				
L ≤ 5	0.08 < W ≤ 0.15	2																				
L ≤ 3	0.15 < W ≤ 0.20	1																				
-	W>0.2	NG																				
L>5	-	NG																				
08	Printing sawtooth 	<table><tr><th>Length</th><th>Width</th><th>Acc. Qty</th></tr><tr><td>/</td><td>W ≤ 0.2mm</td><td>2</td></tr><tr><td>L ≤ 2</td><td>0.2 < W ≤ 0.3</td><td>1</td></tr><tr><td>L ≤ 2</td><td>W>0.3</td><td>NG</td></tr></table>	Length	Width	Acc. Qty	/	W ≤ 0.2mm	2	L ≤ 2	0.2 < W ≤ 0.3	1	L ≤ 2	W>0.3	NG								
Length	Width	Acc. Qty																				
/	W ≤ 0.2mm	2																				
L ≤ 2	0.2 < W ≤ 0.3	1																				
L ≤ 2	W>0.3	NG																				

11.7. Classification of Defects

12.7.1 Visual defects (Except no / wrong label) are treated as minor defect and electrical defect is major.

12.7.2 Two minor defects are equal to one major in lot sampling inspection.

11.8. Identification/marketing criteria

Any unit with illegible / wrong /double or no marking/ label shall be rejected.

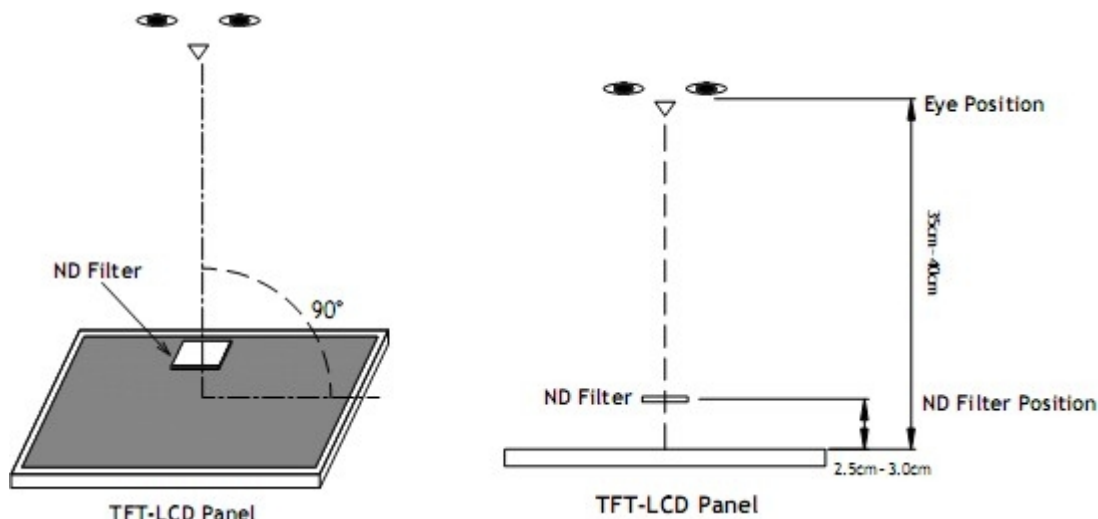
11.9. Packaging

12.9.1 There should be no damage of the outside carton box, each packaging box should have one identical label.

12.9.2 Modules inside package box should have compliant mark.

12.9.3 All direct package materials shall offer ESD protection

Note1: Bright dot is defined as the defective area of the dot is larger than 50% of one sub-pixel area.



Bright dot: The bright dot size defect at black display pattern. It can be recognized by 2% transparency of filter when the distance between eyes and panel is 350mm $\pm$ 50mm.

Dark dot: Cyan, Magenta or Yellow dot size defect at white display pattern. It can be recognized by 5% transparency of filter when the distance between eyes and panel is 350mm $\pm$ 50mm.

Note2: Mura on display which appears darker / brighter against background brightness on parts of display area.

12. Reliability Specification

No	Item	Condition	Quantity	Criteria
1	High Temperature Operating	+80°C, 96Hrs	2	GB/T2423.2-2008
2	Low Temperature Operating	-30°C, 96Hrs	2	GB/T2423.1-2008
3	High Humidity Storage	+50°C, 90%RH, 96Hrs	2	GB/T2423.3-2016
4	High Temperature Storage	+80°C, 96Hrs	2	GB/T2423.2-2008
5	Low Temperature Storage	-30°C, 96Hrs	2	GB/T2423.1-2008
6	Thermal Cycling Test Storage	-20°C, 60min~+70°C, 60min, 20 cycles.	2	GB/T2423.22-2012
7	Packing vibration	Frequency range:10Hz~50Hz Acceleration of gravity:5G X, Y, Z 30 min for each direction.	-	GB/T5170.14-2009
8	Electrical Static Discharge	Air: $\pm 8\text{kV } 150\text{pF}/330\ \Omega$ 5 times Contact: $\pm 4\text{kV } 150\text{pF}/330\ \Omega$ 5 times	2	GB/T17626.2-2018
9	Drop Test (Packaged)	Height:80 cm,1 corner, 3 edges, 6 surfaces.	-	GB/T2423.7-2018

Note1. No defection cosmetic and operational function allowable.

Note2. Total current Consumption should be below double of initial value

13. Precautions and Warranty

13.1. Safety

- 13.1.1. The liquid crystal in the LCD is poisonous. Do not put it in your mouth. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and water.
- 13.1.2. Since the liquid crystal cells are made of glass, do not apply strong impact on them. Handle with care.

13.2. Handling

- 13.2.1. Reverse and use within ratings in order to keep performance and prevent damage.
- 13.2.2. Do not wipe the polarizer with dry cloth, as it might cause scratch. If the surface of the LCD needs to be cleaned, wipe it swiftly with cotton or other soft cloth soaked with petroleum IPA, do not use other chemicals.

13.3. Storage

- 13.3.1. Do not store the LCD module beyond the specified temperature ranges.
- 13.3.2. Strong light exposure causes degradation of polarizer and color filter.

13.4. Metal Pin (Apply to Products with Metal Pins)

13.4.1. Pins of LCD and Backlight

- 13.4.1.1. Solder tip can touch and press on the tip of Pin LEAD during the soldering

13.4.1.2. Recommended Soldering Conditions

Solder Type: Sn96.3~94-Ag3.3~4.3-Cu0.4~1.1

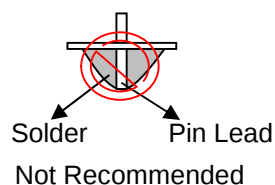
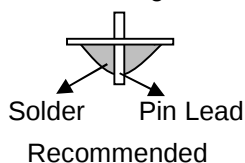
Maximum Solder Temperature: 370°C

Maximum Solder Time: 3s at the maximum temperature

Recommended Soldering Temp: 350±20°C

Typical Soldering Time: ≤3s

13.4.1.3. Solder Wetting



13.4.2. Pins of EL

- 13.4.2.1. Solder tip can touch and press on the tip of EL leads during soldering.

- 13.4.2.2. No Solder Paste on the soldering pad on the motherboard is recommended.

13.4.2.3. Recommended Soldering Conditions

Solder type: Nippon Alimit Leadfree SR-34, size 0.5mm

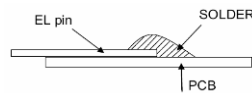
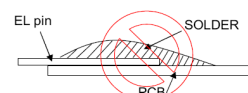
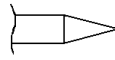
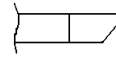
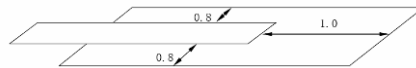
Recommended Solder Temperature: 270~290°C

Typical Soldering Time: ≤2s

Minimum solder distance from EL lamp (body): 2.0mm

- 13.4.2.4. No horizontal press on the EL leads during soldering.

- 13.4.2.5. 180° bend EL leads three times is not allowed.

13.4.2.6. Solder Wetting**Recommended****Not Recommended****13.4.2.7. The type of the solder iron:****Recommended****Not Recommended****13.4.2.8. Solder Pad****13.5.Operation**

- 13.5.1. Do not drive LCD with DC voltage
- 13.5.2. Response time will increase below lower temperature
- 13.5.3. Display may change color with different temperature
- 13.5.4. Mechanical disturbance during operation, such as pressing on the display area, may cause the segments to appear “fractured”.
- 13.5.5. Do not connect or disconnect the LCM to or from the system when power is on.
- 13.5.6. Never use the LCM under abnormal condition of high temperature and high humidity.
- 13.5.7. Module has high frequency circuits. Sufficient suppression to the electromagnetic interface shall be done by system manufacturers. Grounding and shielding methods may be important to minimize the interference.
- 13.5.8. *Do not display the fixed pattern for long time (we suggest the time not longer than one hour) because it will develop image sticking due to the TFT structure.*

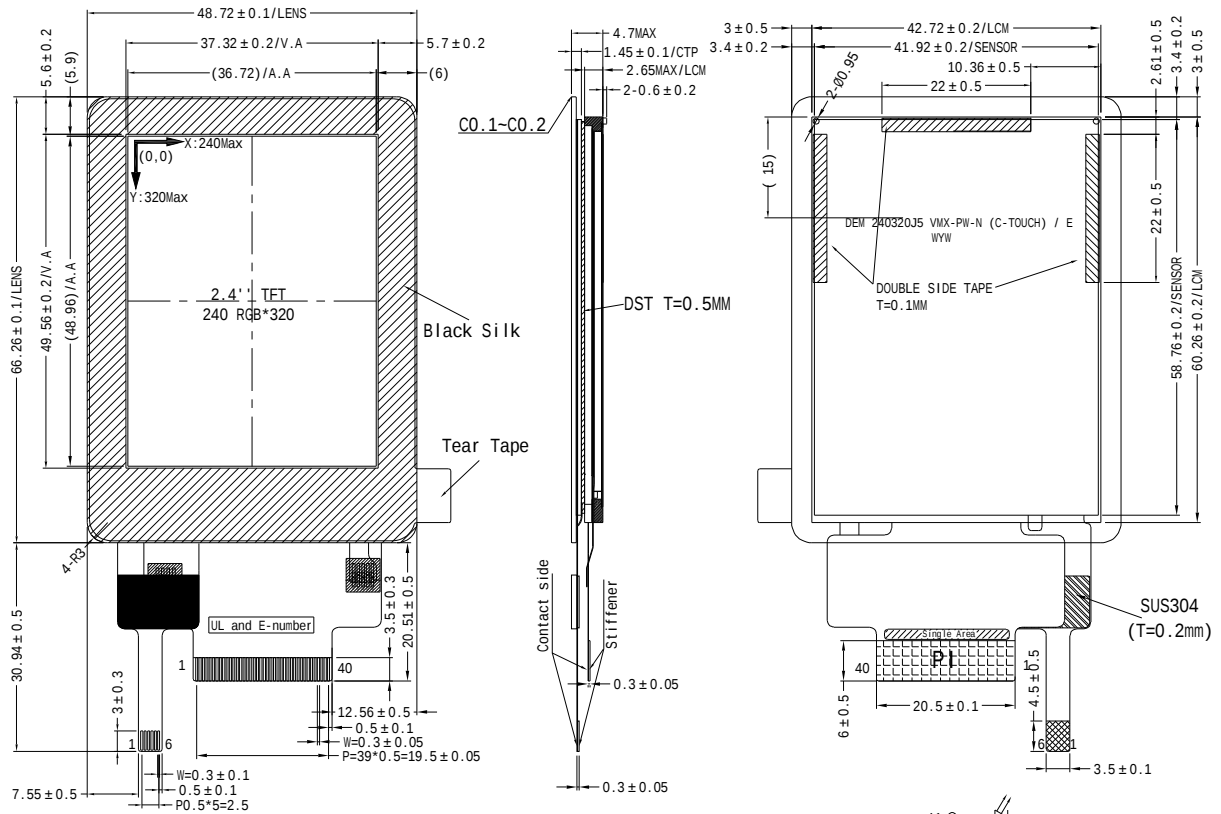
13.6.Static Electricity

- 13.6.1. CMOS LSIs are equipped in this unit, so care must be taken to avoid the electro-static charge, by ground human body, etc.
- 13.6.2. The normal static prevention measures should be observed for work clothes and benches.
- 13.6.3. The module should be kept into anti-static bags or other containers resistant to static for storage.

13.7.Limited Warranty

- 13.7.1. Our warranty liability is limited to repair and/or replacement. We will not be responsible for any consequential loss.
- 13.7.2. If possible, we suggest customer to use up all modules in six months. If the module storage time over twelve months, we suggest that recheck it before the module be used.
- 13.7.3. After the product shipped, any product quality issues must be feedback within three months, otherwise, we will not be responsible for the subsequent or consequential events.

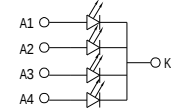
14. Outline Drawing



NOTES:

1. Display Size: 2.4" TFT IPS
2. Viewing Direction: Full View
3. Display Mode: Transmissive/Normal Black/Anti-Glare
4. Operation Temperature: -30 °C to +80 °C
5. Storage Temperature: -30 °C to +80 °C
6. Driver IC: ST7789T3
7. Power Supply Voltage: 2.8 V
8. Backlight: White(4LED)/3.1V(TYP)/60mA
9. LCM Luminance: 425cd/m² (With CTP)
10. RoHS must be complied

* The dimension with mark brackets "(") just for reference



Backlight LED Circuit: 4×1=4(LED)
If=15mA~60mA; Vf=2.8~3.4V
LED Life 50K/Hrs

PIN	SYMBOL
1	GND
2	SCL
3	SDA
4	INT
5	RESET
6	VCC

Item	CTP Description	Item	Main layer define	Thickness/materials
1	IC	FT5446	1	Lens
2	Interface	IIC	2	Optical Glue
3	Operation voltage	2.8~3.3V	3	sensor
4	Interface signal voltage	2.8~3.3V		
5	Surface hardness	= 6H		
6	Operation temperature	-30 °C~+80 °C		
7	Storage temperature	-30 °C~+80 °C		
8	Strengthened Type	Chemical		
9	Transmittance	= 85%		
10	Origin of coordinates	T/L		
11	Resolution Ratio	240*320		

General Tolerance ±	1	2	3	4
0-5	0.05	0.1	0.1	0.2
5-10	0.05	0.1	0.1	0.2
10-50	0.05	0.1	0.2	0.3
50-100	0.1	0.2	0.3	0.5
100-150	0.1	0.2	0.5	0.8

PIN	SYMBOL
1	DB10
2	DB11
3	DB12
4	DB13
5	GND
6	VCC
7	/CS
8	RS
9	/WR
10	/RD
11	IM0
12	IM3
13	IM2
14	SDI
15	SDO
16	NC(YU)
17	NC(XL)
18	NC(YD)
19	NC(XR)
20	LED-K
21	LED-A1
22	LED-A2
23	LED-A3
24	LED-A4
25	DB14
26	DB1
27	DB2
28	DB3
29	DB4
30	DB5
31	DB6
32	DB7
33	DB8
34	/RESET
35	VCI
36	VCC
37	IM1
38	DB15
39	DB16
40	DB17